

## Electronic Acknowledgement Receipt

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<b>Application Number:</b>	10597937
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<b>Confirmation Number:</b>	8123
<b>Title of Invention:</b>	Conductive adhesive
<b>First Named Inventor/Applicant Name:</b>	Nobuto Terada
<b>Customer Number:</b>	20995
<b>Filer:</b>	Katsuhiro Arai/Sharon Starr
<b>Filer Authorized By:</b>	Katsuhiro Arai
<b>Attorney Docket Number:</b>	WAKAB98.001APC
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### Payment information:

Submitted with Payment	yes
Payment was successfully received in RAM	\$ 180
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
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1	Information Disclosure Statement (IDS) Filed	IDS_FormSB08aWithAttachment_WAKAB98-001APC.pdf	278637	no	7
<b>Warnings:</b>					
<b>Information:</b>					
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2	Miscellaneous Incoming Letter	IDS_GermanOfficeActionWithEnglishTranslation_WAKAB98-001APC.pdf	225859	no	5
<b>Warnings:</b>					
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3	Miscellaneous Incoming Letter	IDS_CopiesAbstractOfJapanesePublication_WAKAB98-001APC.pdf	363554	no	9
<b>Warnings:</b>					
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4	Foreign Reference	IDS_DT2446658A1-WAKAB98-001APC.pdf	835111	no	18
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<b>Information:</b>					
5	Foreign Reference	IDS_DE3443789A1_WAKAB98-001APC.pdf	2228940	no	50
<b>Warnings:</b>					
<b>Information:</b>					
6	Foreign Reference	IDS_EP0171157B1_WAKAB98-001APC.pdf	476135	no	8
<b>Warnings:</b>					
<b>Information:</b>					
7	Foreign Reference	IDS_DE3586372T2_WAKAB98-001APC.pdf	536677	no	12
<b>Warnings:</b>					
<b>Information:</b>					
8	Foreign Reference	IDS_DE102004031188A1_WAKAB98-001APC.pdf	559356	no	8
<b>Warnings:</b>					
<b>Information:</b>					
9	Foreign Reference	IDS_DE102004031189A1_WAKAB98-001APC.pdf	552923	no	8
<b>Warnings:</b>					

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10	Foreign Reference	IDS_DE102004031190A1_ WAKAB98-001APC.pdf	574350	no	9
<b>Warnings:</b>					
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11	Fee Worksheet (PTO-06)	fee-info.pdf	8175	no	2
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